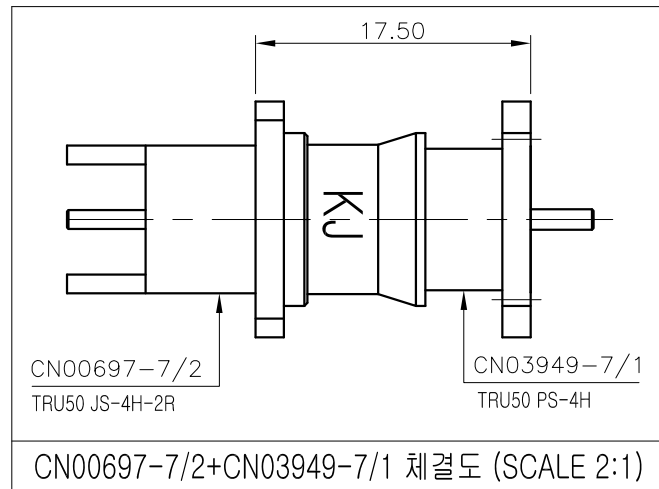
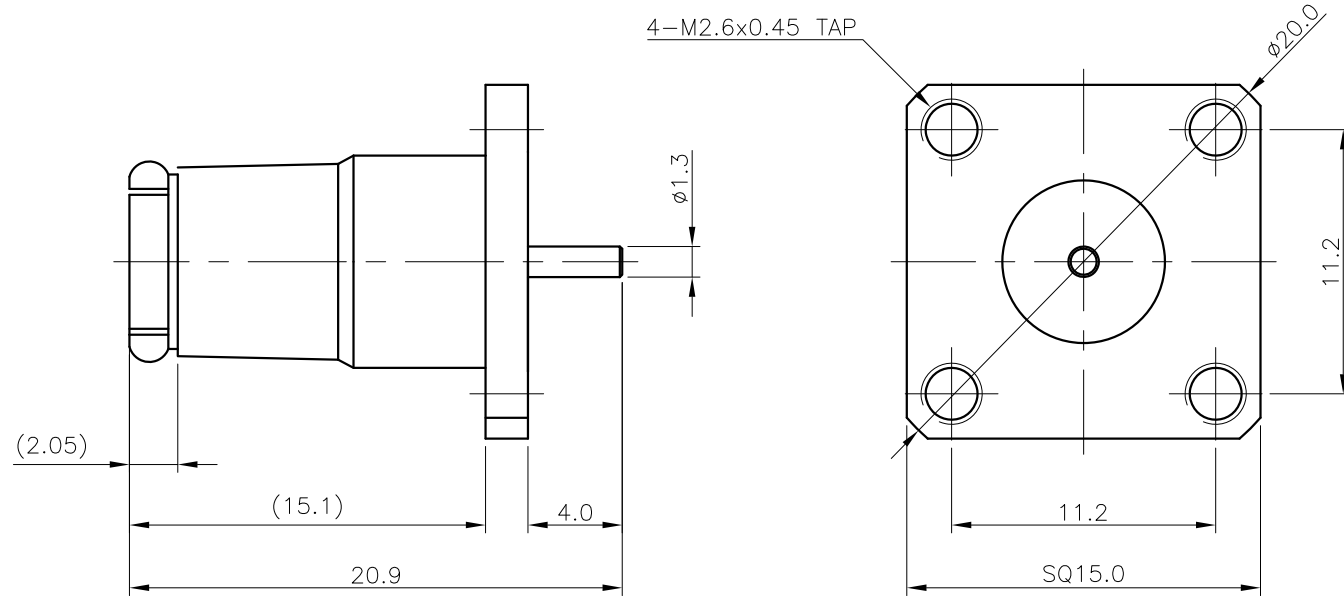


REVISION					
REV	DESCRIPTION	DRAWN	APPR	DATE	
1R	Initial Registration	S.Y.EUN	I.C.KIM	2020.09.11.	
1	[설변처리No.202101] 조립 후 핀 높이 개선 치수 변경	I.C.KIM		2021.01.26.	



4	JACK	1	BeCu C17300	Nickel Plate	DJA00039-5/1
3	INSULATOR	1	TEFLON		DIN03170-N/1
2	CONTACT	1	MBsBD C3604BD-F	Gold Plate	DCT04154-5/2 DCT04154-5/1
1	BODY	1	MBsBD C3604BD-F	Nickel Plate	DBD04657-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2021. 01. 26.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle ±1°	APPROVED BY			
MATERIAL _____	CHECKED BY				TITLE TRU50 SOLDER END PS-4H
	DRAWN BY	I.C.KIM			
FINISH _____	SCALE 3/1	UNIT mm		A4	DWG NO. CN03949-7/1
					REVISION 1